Preferred Device

SWITCHMODE™ Power Rectifier

D²PAK Power Surface Mount Package

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Ultrafast 60 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL94, V_O @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 V
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to Industrial Standard TO-220 Package

Mechanical Characteristics

- Case: Epoxy, Molded, Epoxy Meets UL94, VO
- Weight: 1.7 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units Per Plastic Tube
- Marking: U1660
- Device Meets MSL1 Requirements
- ESD Ratings: Machine Model, C (>400 V)

Human Body Model, 3B (>8000 V)

MAXIMUM RATINGS (Per Leg)

| Rating | Symbol | Value | Unit |
|---|--|----------------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 600 | V |
| Average Rectified Forward Current (Rated V_R , $T_C = 150$ °C) Total Device | I _{F(AV)} | 8.0 16 | Α |
| Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz, T _C = 150°C) | I _{FM} | 16 | A |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | I _{FSM} | I _{FSM} 100 | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -65 to +175 | °C |

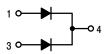
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



ON Semiconductor®

http://onsemi.com

ULTRAFAST RECTIFIER 16 AMPERES 600 VOLTS



D²PAK CASE 418B STYLE 3



MARKING DIAGRAM



U1660 = Device Code

ORDERING INFORMATION

| Device | Package Shipping† | |
|--------------|--------------------|-----------------|
| MURB1660CT | D ² PAK | 50 Units/Rail |
| MURB1660CTT4 | D ² PAK | 800/Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

THERMAL CHARACTERISTICS (Per Leg)

| Rating | Symbol | Value | Unit |
|--|-----------------|-------|------|
| Maximum Thermal Resistance, Junction to Case | $R_{	heta JC}$ | 2.0 | °C/W |
| Maximum Thermal Resistance, Junction to Ambient (Note 1) | $R_{\theta JA}$ | 50 | °C/W |
| Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds | TL | 260 | °C |

ELECTRICAL CHARACTERISTICS (Per Leg)

| Characteristic | Symbol | Max | Unit |
|--|-----------------|--------------|-------|
| Maximum Instantaneous Forward Voltage (Note 2) ($i_F = 8.0 \text{ Amp}, T_C = 150^{\circ}\text{C}$) ($i_F = 8.0 \text{ Amp}, T_C = 25^{\circ}\text{C}$) | VF | 1.20 1.50 | Volts |
| Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_C = 150^{\circ}C$) (Rated dc Voltage, $T_C = 25^{\circ}C$) | i _R | 500 10 | μΑ |
| Maximum Reverse Recovery Time $ (I_F = 1.0 \text{ Amp, di/dt} = 50 \text{ Amp/}\mu\text{s}) $ $ (I_F = 0.5 \text{ Amp, } i_R = 1.0 \text{ Amp, } I_{REC} = 0.25 \text{ Amp}) $ | t _{rr} | 60 50 | ns |

- 1. See Chapter 7 for mounting conditions.
- 2. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤2.0%.

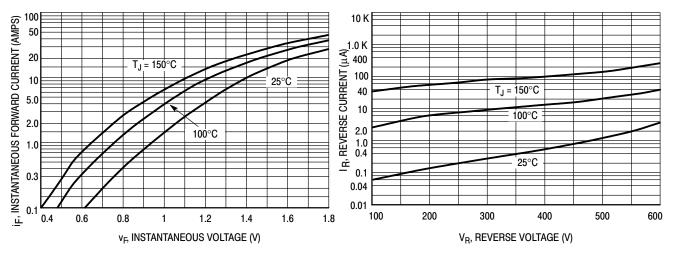


Figure 1. Typical Forward Voltage, Per Leg

Figure 2. Typical Reverse Current, Per Leg

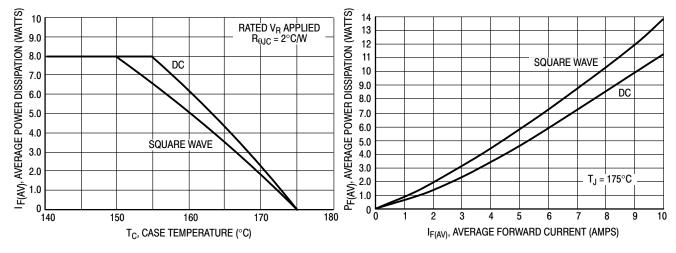


Figure 3. Current Derating, Case, Per Leg

Figure 4. Power Dissipation, Per Leg

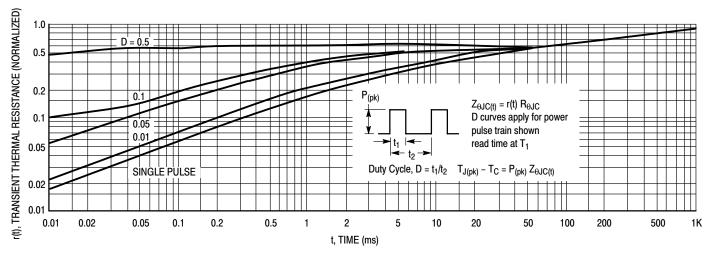


Figure 5. Thermal Response

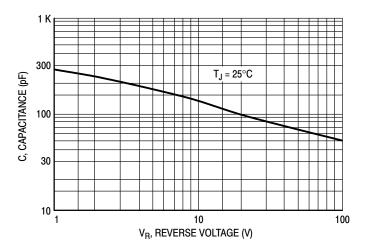
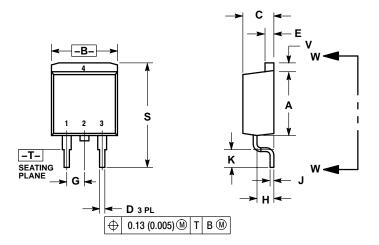


Figure 6. Typical Capacitance, Per Leg

PACKAGE DIMENSIONS

D²PAK CASE 418B-04 **ISSUE J**



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

| | INCHES | | MILLIMETERS | | |
|-----|-----------|-------|-------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.340 | 0.380 | 8.64 | 9.65 | |
| В | 0.380 | 0.405 | 9.65 | 10.29 | |
| С | 0.160 | 0.190 | 4.06 | 4.83 | |
| D | 0.020 | 0.035 | 0.51 | 0.89 | |
| E | 0.045 | 0.055 | 1.14 | 1.40 | |
| F | 0.310 | 0.350 | 7.87 | 8.89 | |
| G | 0.100 | BSC | 2.54 BSC | | |
| Н | 0.080 | 0.110 | 2.03 | 2.79 | |
| J | 0.018 | 0.025 | 0.46 | 0.64 | |
| K | 0.090 | 0.110 | 2.29 | 2.79 | |
| L | 0.052 | 0.072 | 1.32 | 1.83 | |
| M | 0.280 | 0.320 | 7.11 | 8.13 | |
| N | 0.197 REF | | 5.00 | REF | |

0.039 REF 0.99 REF 0.575 0.625 14.60 15.88

STYLE 3:

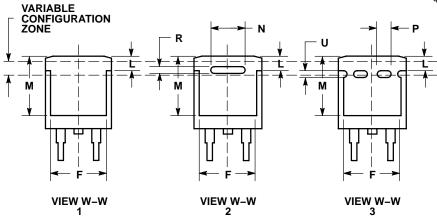
R

- PIN 1. ANODE 2. CATHODE
 - 3.

0.079 REF

0.045 0.055

ANODE CATHODE



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